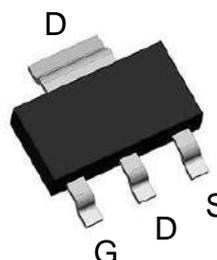


## N-Channel Enhancement Mode Power MOSFET

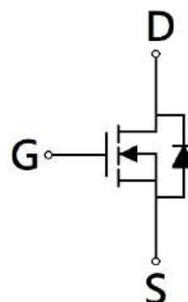
### Features:

- Low On Resistance
- Low Gate Charge
- Fast Switching Characteristic

SOT-223



$BV_{DSS}$	100V
$I_D @ V_{GS}=10V, T_C=25^\circ C$	8A
$I_D @ V_{GS}=10V, T_A=25^\circ C$	3.3A
$R_{DS(ON)}$ typ. @ $V_{GS}=10V, I_D=3A$	92m $\Omega$



G : Gate S : Source D : Drain

### Ordering Information

Device	Package	Shipping
KLE080N10	SOT-223 (Pb-free lead plating and halogen-free package)	2500 pcs / Tape & Reel

### Absolute Maximum Ratings (T<sub>A</sub>=25°C)

Parameter	Symbol	Limits	Unit	
Drain-Source Voltage	V <sub>DS</sub>	100	V	
Gate-Source Voltage	V <sub>GS</sub>	±20		
Continuous Drain Current @ V <sub>GS</sub> =10V, T <sub>C</sub> =25°C	I <sub>D</sub>	8	A	
Continuous Drain Current @ V <sub>GS</sub> =10V, T <sub>C</sub> =100°C		5		
Continuous Drain Current @ V <sub>GS</sub> =10V, T <sub>A</sub> =25°C		3.3		
Continuous Drain Current @ V <sub>GS</sub> =10V, T <sub>A</sub> =70°C		2.6		
Pulsed Drain Current		I <sub>DM</sub>		24
Continuous Body Diode Forward Current @ T <sub>C</sub> =25°C	I <sub>S</sub>	9		
Avalanche Current @ L=0.1mH	I <sub>AS</sub>	10		
Avalanche Energy @ L=0.5mH	E <sub>AS</sub>	12	mJ	
Total Power Dissipation	P <sub>D</sub>	T <sub>C</sub> =25°C	18	W
		T <sub>C</sub> =100°C	7	
		T <sub>A</sub> =25°C	2.7	
		T <sub>A</sub> =70°C	1.7	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55~+150	°C	

### Thermal Data

Parameter	Symbol	Steady State	Unit
Thermal Resistance, Junction-to-case	R <sub>θJC</sub>	7	°C/W
Thermal Resistance, Junction-to-ambient	R <sub>θJA</sub>	46	

Note:

- \*a. The power dissipation P<sub>D</sub> is based on T<sub>J(MAX)</sub>=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.
- \*b. The value of R<sub>θJA</sub> is measured with the device mounted on 1 in<sup>2</sup> FR -4 board with 2 oz. copper, in a still air environment with T<sub>A</sub>=25°C. The power dissipation P<sub>D</sub> is based on R<sub>θJA</sub> and the maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.
- \*c. Repetitive rating, pulse width limited by junction temperature T<sub>J(MAX)</sub>=150°C. Ratings are based on low frequency and low duty cycles to keep initial T<sub>J</sub>=25°C.

**Electrical Characteristics (T<sub>A</sub>=25°C, unless otherwise specified)**

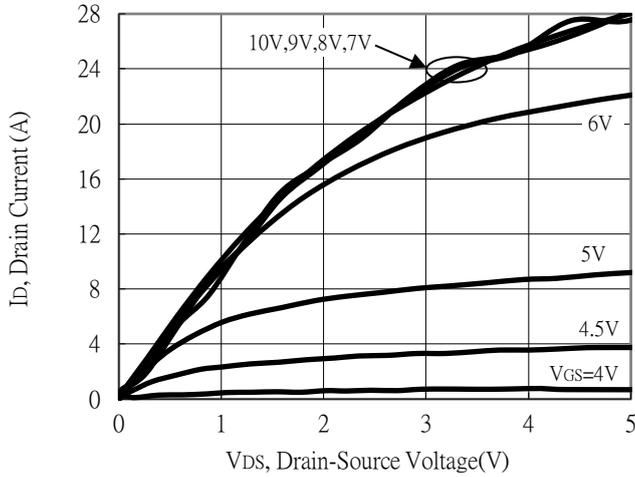
Symbol	Min.	Typ.	Max.	Unit	Test Conditions
<b>Static</b>					
BV <sub>DSS</sub>	100	-	-	V	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA
V <sub>GS(th)</sub>	2	-	4		V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA
GFS	-	6	-	S	V <sub>DS</sub> =10V, I <sub>D</sub> =10A
I <sub>GSS</sub>	-	-	±100	nA	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V
I <sub>DSS</sub>	-	-	1	μA	V <sub>DS</sub> =80V, V <sub>GS</sub> =0V
R <sub>DS(ON)</sub>	-	92	120	mΩ	V <sub>GS</sub> =10V, I <sub>D</sub> =3A
<b>Dynamic</b>					
C <sub>iss</sub>	-	320	-	pF	V <sub>DS</sub> =50V, V <sub>GS</sub> =0V, f=1MHz
C <sub>oss</sub>	-	42	-		
C <sub>rss</sub>	-	24	-		
R <sub>g</sub>	-	2.8	-	Ω	f=1MHz
Q <sub>g</sub> *1, 2	-	7	-	nC	V <sub>DS</sub> =50V, I <sub>D</sub> =3A, V <sub>GS</sub> =10V
Q <sub>gs</sub> *1, 2	-	1.8	-		
Q <sub>gd</sub> *1, 2	-	2	-		
t <sub>d(ON)</sub> *1, 2	-	7	-	ns	V <sub>DS</sub> =50V, I <sub>D</sub> =3A, V <sub>GS</sub> =10V, R <sub>GS</sub> =1Ω
t <sub>r</sub> *1, 2	-	16	-		
t <sub>d(OFF)</sub> *1, 2	-	15	-		
t <sub>f</sub> *1, 2	-	8	-		
<b>Source-Drain Diode</b>					
V <sub>SD</sub> *1	-	0.83	1.2	V	I <sub>S</sub> =3A, V <sub>GS</sub> =0V
t <sub>rr</sub>	-	24	-	ns	I <sub>F</sub> =3A, dI <sub>F</sub> /dt=100A/μs
Q <sub>rr</sub>	-	28	-	nC	

Note:

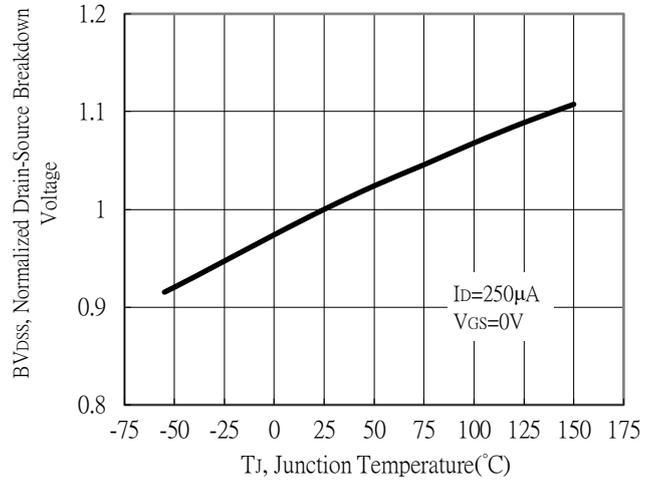
- \*1. Pulse Test : Pulse Width ≤300μs, Duty Cycle≤2%
- \*2. Independent of operating temperature

## Typical Characteristics

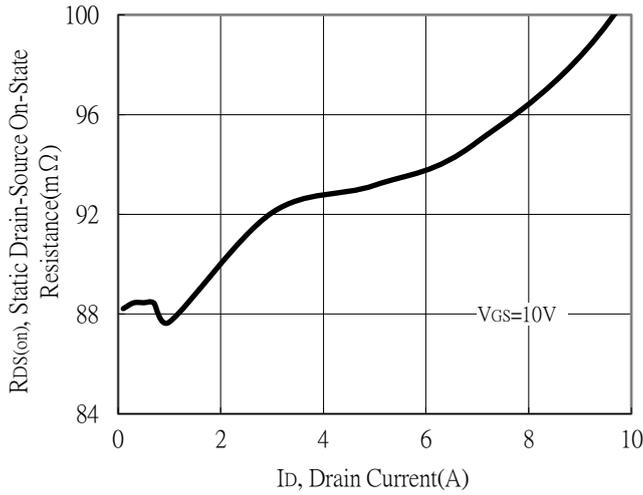
Typical Output Characteristics



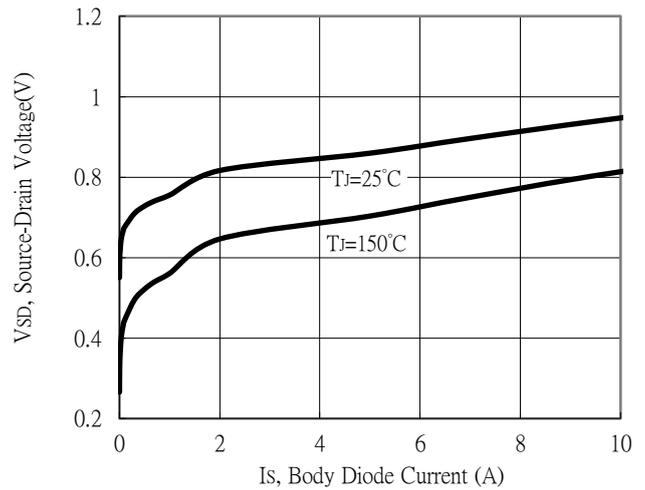
Breakdown Voltage vs Ambient Temperature



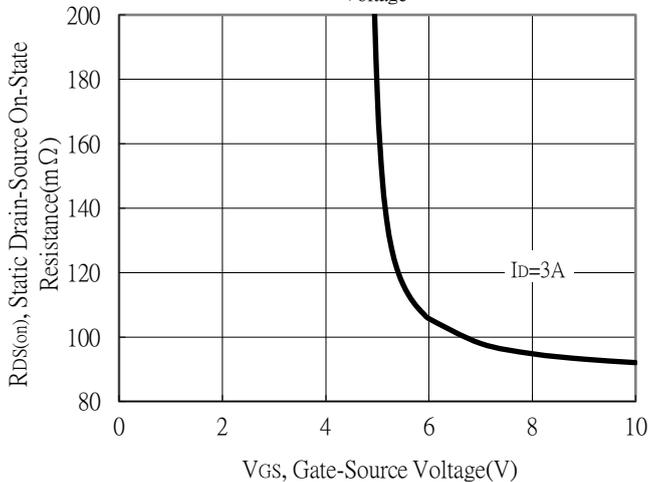
Static Drain-Source On-State resistance vs Drain Current



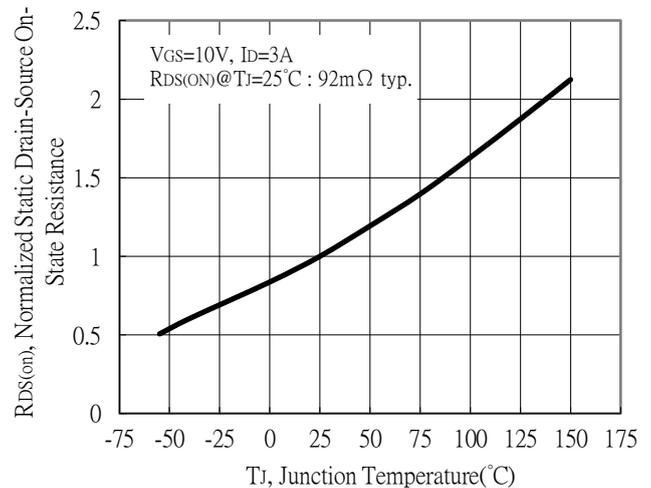
Body Diode Current vs Source-Drain Voltage



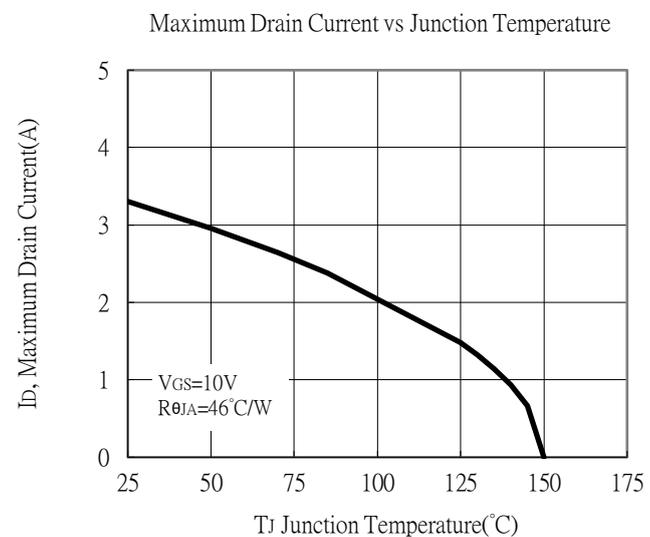
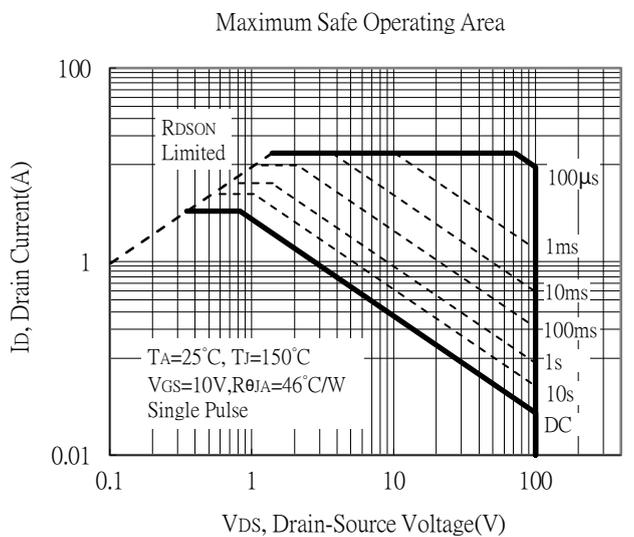
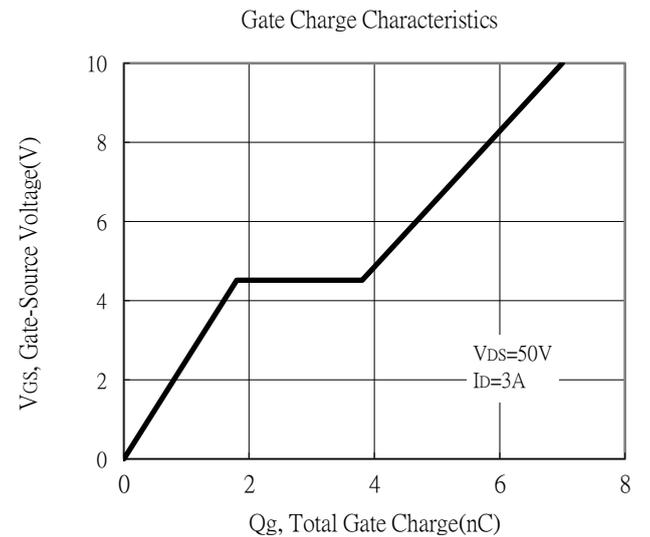
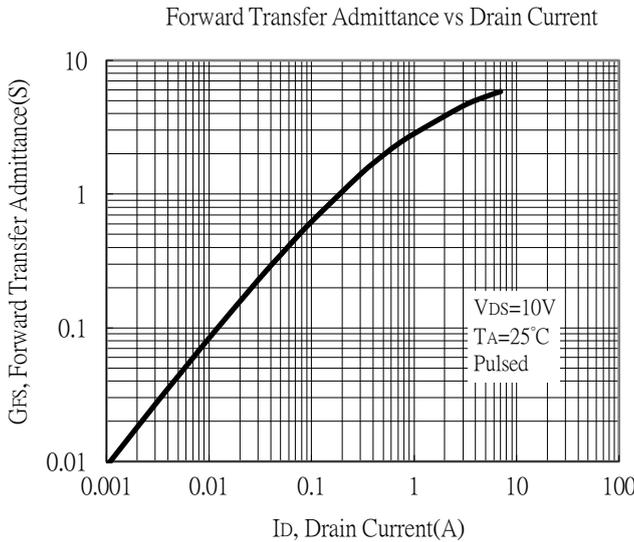
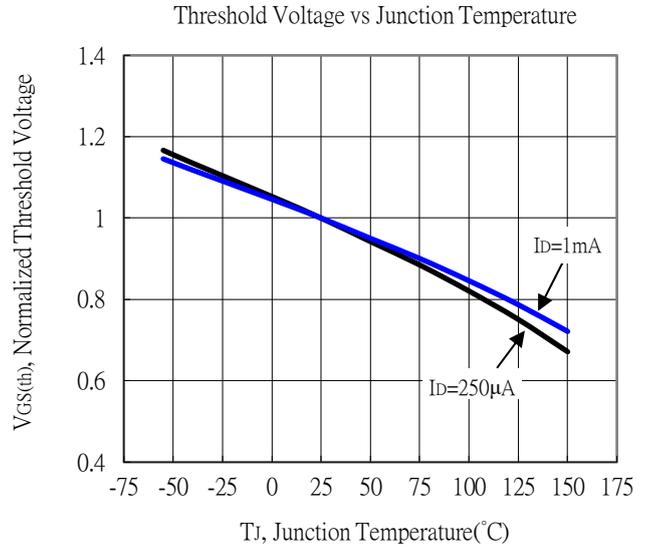
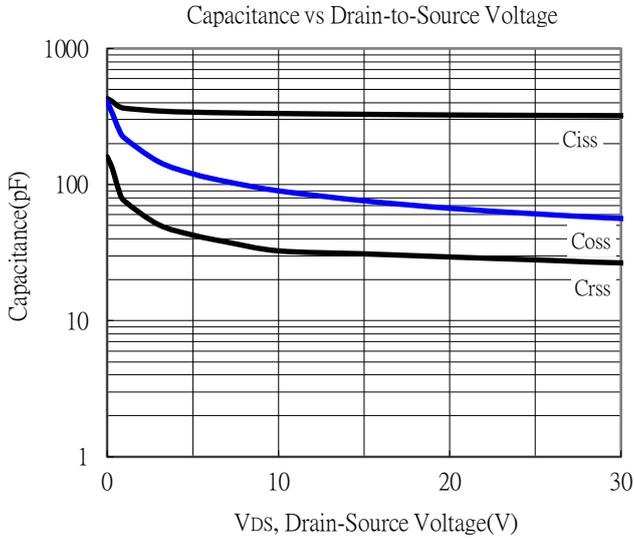
Static Drain-Source On-State Resistance vs Gate-Source Voltage



Drain-Source On-State Resistance vs Junction Temperature

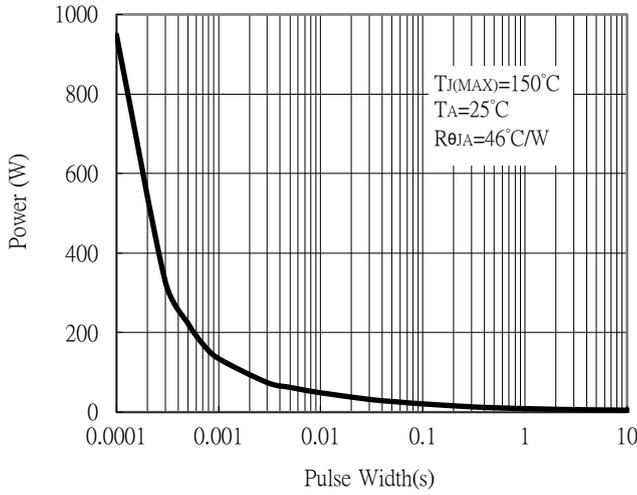


**Typical Characteristics (Cont.)**

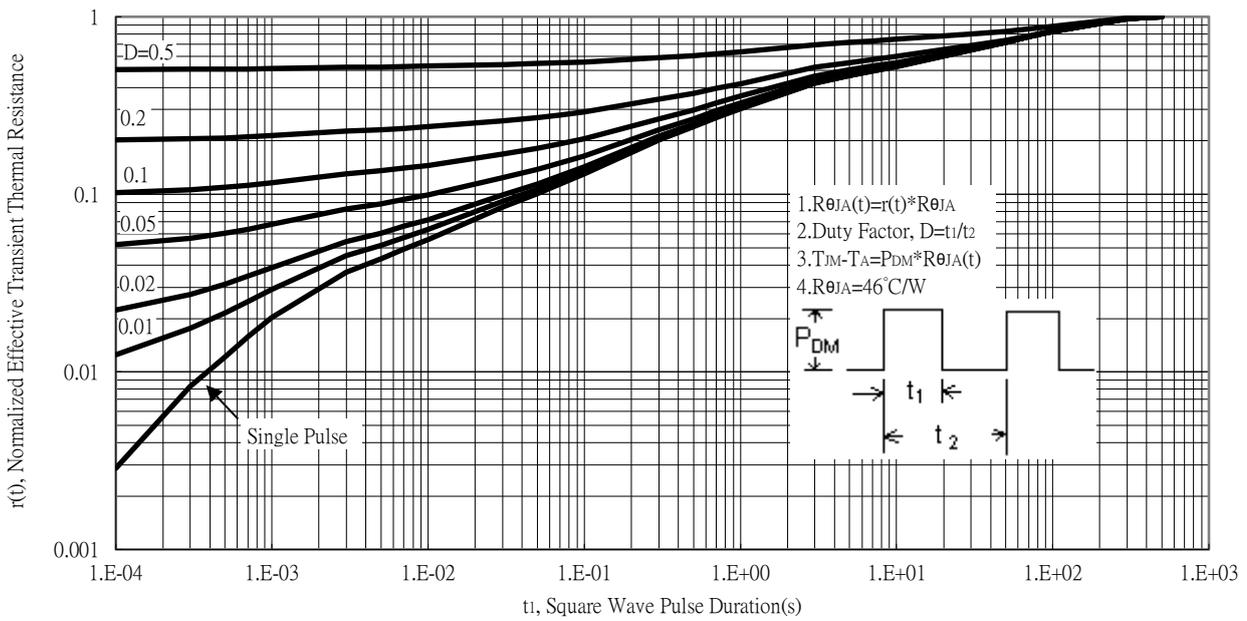


### Typical Characteristics (Cont.)

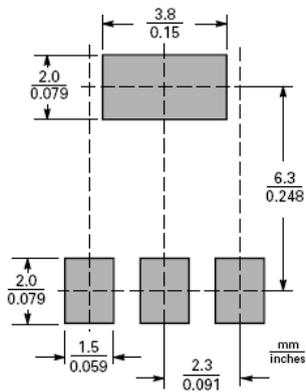
Single Pulse Power Rating, Junction to Ambient



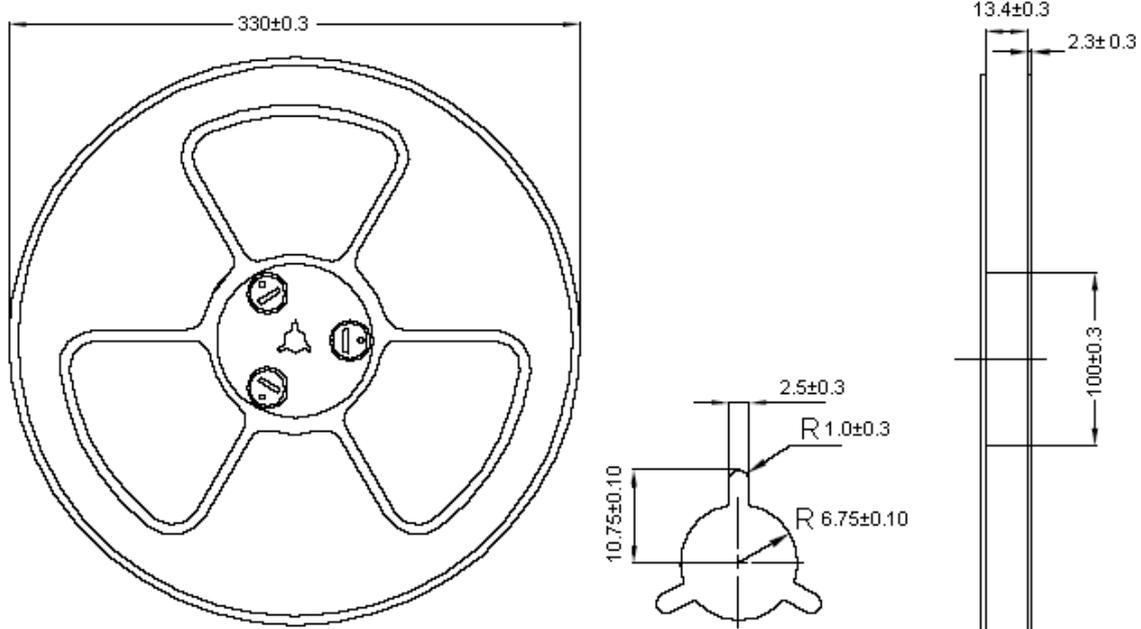
Transient Thermal Response Curves



### Recommended soldering footprint



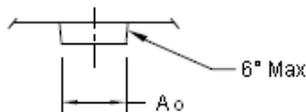
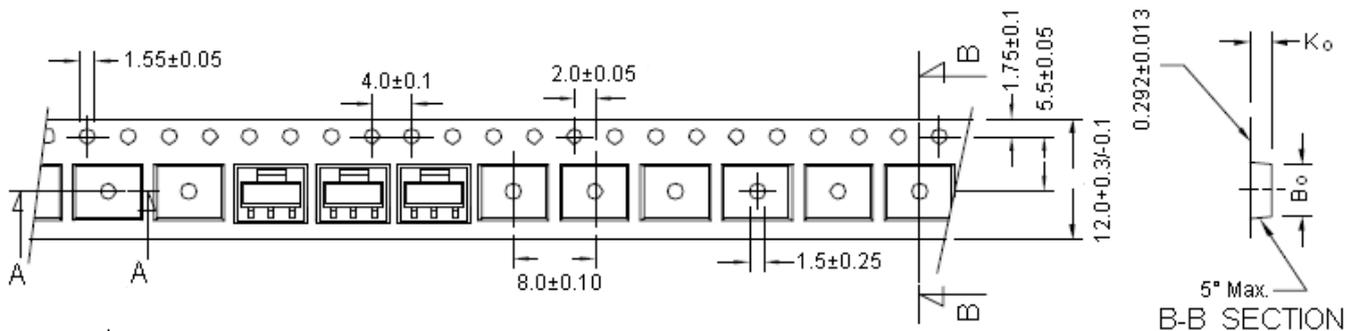
### Reel Dimension



UNIT : mm

NOTE : 1. Material : Anti-static polystyrene  
 2. Surface resistivity  $10^9 \Omega/\text{sq}$

### Carrier Tape Dimension



$A_o = 6.40 \pm 0.1$   
 $B_o = 5.20 \pm 0.1$   
 $K_o = 2.10 \pm 0.1$

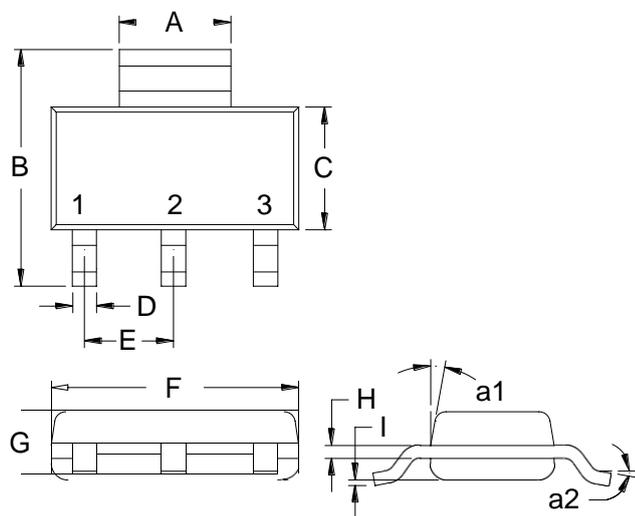
#### A-A SECTION

Notes:

1. 10 sprocket hole pitch cumulative tolerance  $\pm 0.2$ .
2. Camber not to exceed 1mm in 100mm.
3. Material: conductive black polystyrene
4.  $A_o$  &  $B_o$  measured on a plane 0.3mm above the bottom of the pocket.
5.  $K_o$  measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
6. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.

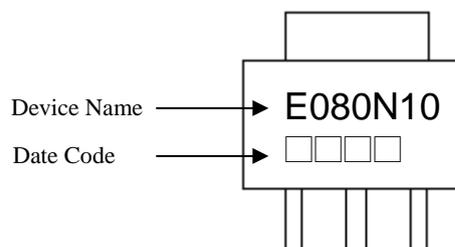
Uni : millimeter

### SOT-223 Dimension



3-Lead SOT-223 Plastic  
 Surface Mounted Package

Marking:



Style: Pin 1.Gate 2.Drain 3.Source

Date Code(counting from left to right) :

1<sup>st</sup> code: year code, the last digit of Christian year

2<sup>nd</sup> code : month code, Jan→A, Feb→B, Mar→C,

Apr→D, May→E, Jun→F, Jul→G, Aug→H,

Sep→J, Oct→K, Nov→L, Dec→M

3<sup>rd</sup> and 4<sup>th</sup> codes : production serial number, 01~99

\*: Typical

DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.1142	0.1220	2.90	3.10	G	0.0551	0.0709	1.40	1.80
B	0.2638	0.2874	6.70	7.30	H	0.0098	0.0138	0.23	0.35
C	0.1299	0.1457	3.30	3.70	I	0.0008	0.0039	0.02	0.10
D	0.0236	0.0315	0.60	0.80	a1	*13°	-	*13°	-
E	*0.0906	-	*2.30	-	a2	0°	10°	0°	10°
F	0.2480	0.2638	6.30	6.70					